

**ORGANISATION MONDIALE
DU COMMERCE**

**ORGANIZACIÓN MUNDIAL
DEL COMERCIO**

WORLD TRADE ORGANIZATION

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15 August 1997

**MARRAKESH AGREEMENT ESTABLISHING
THE WORLD TRADE ORGANIZATION
DONE AT MARRAKESH ON 15 APRIL 1994**

GENERAL AGREEMENT ON TARIFFS AND TRADE 1994

**CERTIFICATION OF MODIFICATIONS TO
SCHEDULE LXXX - EUROPEAN COMMUNITIES**

TRANSMISSION OF CERTIFIED TRUE COPY

I have the honour to furnish herewith a certified true copy of the Certification of Modifications to Schedule LXXX - European Communities, dated 2 July 1997.

R. Ruggiero
Director-General

**SCHEDULES OF TARIFF CONCESSIONS TO THE
GENERAL AGREEMENT ON TARIFFS AND TRADE 1994**

CERTIFICATION OF MODIFICATIONS

SCHEDULE LXXX - EUROPEAN COMMUNITIES

WHEREAS the CONTRACTING PARTIES to the General Agreement on Tariffs and Trade 1947 adopted, on 26 March 1980, a Decision on Procedures for Modification and Rectification of Schedules of Tariff Concessions (BISD 27S/25);

WHEREAS in accordance with the provisions of the above-mentioned Decision, a draft containing modifications to Schedule LXXX - European Communities was communicated to all Members of the World Trade Organization in document G/MA/TAR/RS/16 on 2 April 1997;

IT IS HEREBY CERTIFIED that the modifications to Schedule LXXX - European Communities are established in conformity with the above-mentioned Decision.

The annexed modifications shall become effective on 2 July 1997.

This Certification is deposited with the Director-General of the World Trade Organization, who shall promptly furnish a certified true copy to each Member of the World Trade Organization. It shall be registered in accordance with the provisions of Article 102 of the Charter of the United Nations.

DONE at Geneva this second day of July, one thousand nine hundred and ninety-seven.

R. Ruggiero

Certified true copy:

Director-General

SCHEDULE LXXX - EUROPEAN COMMUNITIES

Modifications

2 July 1997

HS96	Description	Base rate	Bound rate	Implementation	Present concession established	INR	GATT Schedule	Earlier INRs	ODCs
3818 00	Chemical elements doped for use in electronics, in the form of discs, wafers or similar forms; chemical compounds doped for use in electronics				WT/Let				0.0
3818 00 10 -	Doped silicon	6.9	0.0	2000	WT/Let				0.0
3818 00 90 -	Other	6.9	0.0	2000	WT/Let				0.0
7020 00	Other articles of glass				WT/Let				0.0
7020 00 05 -	Quartz reactor tubes and holders designed for insertion into diffusion and oxidation furnaces for production of semiconductor wafers	4	0.0	2000	WT/Let				0.0
7020 00 10 -	Of fused quartz or other fused silica				WT/Let				0.0
7020 00 30 -	Of glass having a linear coefficient of expansion not exceeding 5 x 10 ⁻⁶ per Kelvin within a temperature range of 0 °C to 300 °C				WT/Let				0.0
7020 00 80 -	Other				WT/Let				0.0
8419	Machinery, plant or laboratory equipment, whether or not electrically heated, for the treatment of materials by a process involving a change of temperature such as heating, cooking, roasting, distilling, rectifying, sterilizing, pasteurizing, steaming, drying, evaporating, vapourizing, condensing or cooling, other than machinery or plant of a kind used for domestic purposes; instantaneous or storage water heaters, non-electric :				WT/Let				0.0
8419 89	-- Other				WT/Let				0.0

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation</u>	<u>Present concession established</u>	<u>Concession first incorporated in a GATT Schedule</u>	<u>Earlier INRs</u>	<u>ODCs</u>
8419 89 10 ---	Cooling towers and similar plant for direct cooling (without a separating wall) by means of recirculated water				WT/Let			0.0
8419 89 15 ---	Apparatus for rapid heating of semiconductor wafers	0.0	0.0	1997	WT/Let			0.0
8419 89 20 ---	Apparatus for chemical vapour deposition on semiconductor wafers	0.0	0.0	1997	WT/Let			0.0
8419 89 25 ---	Apparatus for physical vapour deposition by electronic beam or evaporation on semiconductor wafers	0.0	0.0	1997	WT/Let			0.0
8419 89 30 ---	Vacuum-vapour plant for the deposition of metal				WT/Let			0.0
8419 89 95 ---	Other				WT/Let			0.0
8419 90 -	Parts				WT/Let			0.0
8419 90 10 --	Of heat exchange units, for use in civil aircraft				WT/Let			0.0
8419 90 20 --	Of subheading 8419 20 00				WT/Let			0.0
8419 90 30 --	For apparatus of subheading 8419 89 15 to 841989 25	2.7	0.0	2000	WT/Let			0.0
8419 90 80 --	Other				WT/Let			0.0
8421	Centrifuges, including centrifugal dryers; filtering machinery, for liquids or gases :				WT/Let			0.0
8421 19 --	Other				WT/Let			0.0
8421 19 10 ---	For use in civil aircraft				WT/Let			0.0
8421 19 91 ----	Centrifuges of a kind used in laboratories				WT/Let			0.0
8421 19 93 ----	Centrifuges of a kind used in the manufacturing of semiconductor wafers:				WT/Let			0.0
8421 19 93 ----	Spinners for coating photographic emulsions on semiconductor wafers	0.0	0.0	1997	WT/Let			0.0
8421 19 95 ----	Other	1.5	0.0	2000	WT/Let			0.0

HS96	Description	Base rate	Bound rate	Implementation	Present concession established	INR	Concession first incorporated in a GATT Schedule	Earlier INRs	ODCs
8421 19 97	---- Other				WT/Let				0.0
	- Parts				WT/Let				0.0
	-- Of centrifuges, including centrifugal dryers				WT/Let				0.0
8421 91 10	--- For apparatus of subheading 8421 19 93 or 8421 19 95	2.5	0.0	2000	WT/Let				0.0
8421 91 90	--- Other				WT/Let				0.0
8421 99 00	-- Other				WT/Let				0.0
8424	Mechanical appliances (whether or not hand-operated) for projecting, dispersing or spraying liquids or powders; fire extinguishers, whether or not charged; spray guns and similar appliances; steam or sand blasting machines and similar jet projecting machines :				WT/Let				0.0
8424 89	-- Other				WT/Let				0.0
8424 89 20	--- Spraying appliances for etching, stripping or cleaning semiconductor wafers	0.0	0.0	1997	WT/Let				0.0
8424 89 30	--- Deflash machines for cleaning and removing contaminants from the metal leads of semiconductor packages prior to the electroplating process	2.8	0.0	2000	WT/Let				0.0
8424 89 80	--- Other				WT/Let				0.0
8424 90	- Parts				WT/Let				0.0
8424 90 10	-- Of apparatus of subheading 8424 89 20	2.8	0.0	2000	WT/Let				0.0
8424 90 90	-- Other				WT/Let				0.0
8428	Other lifting, handling, loading or unloading machinery (for example, lifts, escalators, conveyors, teleferics) :				WT/Let				0.0
8428 39	-- Other				WT/Let				0.0
8428 39 10	--- For use in civil aircraft				WT/Let				0.0
	--- Other				WT/Let				0.0

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation</u>	<u>Present</u> <u>concession</u> <u>established</u> <u>INR</u>	<u>Concession first</u> <u>incorporated in a</u> <u>GATT Schedule</u>	<u>Earlier INRs</u>	<u>ODCs</u>
8428 39 91	---- Roller conveyors				WT/Let			0.0
8428 39 93	---- Automated material handling machines for transport, handling and storage of semiconductor wafers, wafer cassettes, wafer boxes and other material for semiconductor devices	0.0	0.0	1997	WT/Let			0.0
8428 39 98	---- Other				WT/Let			0.0
8431	Parts suitable for use solely or principally with the machinery of heading Nos 8425 to 8430 :				WT/Let			0.0
8431 39	-- Other				WT/Let			0.0
8431 39 10	--- Of rolling-mill machinery of subheading 8428 90 30				WT/Let			0.0
8431 39 20	--- Of machinery of subheading 8428 39 93	1.6	0.0	1999	WT/Let			0.0
8431 39 80	--- Other				WT/Let			0.0
8456	Machine-tools for working any material by removal of material, by laser or other light or photon beam, ultrasonic, electro-discharge, electro-chemical, electron beam, ionic-beam or plasma arc processes :				WT/Let			0.0
8456 10	- Operated by laser or other light or photon beam processes				WT/Let			0.0
8456 10 10	-- Of a kind used in the manufacturing of semiconductor wafers or devices	4.7	0.0	2000	WT/Let			0.0
8456 10 90	-- Other				WT/Let			0.0
8456 91 00	-- For dry-etching patterns on semiconductor materials	0.0	0.0	1997	WT/Let			0.0
8456 99	-- Other				WT/Let			0.0
8456 99 10	--- Focused ion beam milling machines for producing or repairing masks and reticles for patterns on semiconductor devices	0.0	0.0	1997	WT/Let			0.0

HS96	Description	Base rate		Bound rate	Implementation	Present concession established	INR	Concession first incorporated in a	
		0.0	0.0					GATT Schedule	Earlier INRs
8456 99 30	--- Apparatus for stripping or cleaning semiconductor wafers	0.0	0.0	1997	WT/Let				0.0
8456 99 90	--- Other				WT/Let				0.0
8462	Machine-tools (including presses) for working metal by forging, hammering or die-stamping; machine-tools (including presses) for working metal by bending, folding, straightening, flattening, shearing, punching or notching; presses for working metal or metal carbides, not specified above :								
	- Bending, folding, straightening or flattening machines (including presses)				WT/Let				0.0
8462 21	-- Numerically controlled				WT/Let				0.0
8462 21 05	--- Of a kind used in manufacturing semiconductor devices	3.2	0.0	2000	WT/Let				0.0
8462 21 10	--- For working flat products				WT/Let				0.0
8462 21 80	--- Other				WT/Let				0.0
8462 29	-- Other				WT/Let				0.0
8462 29 05	--- Of a kind used in manufacturing semiconductor devices	1.7	0.0	2000	WT/Let				0.0
8462 29 10	--- For working flat products				WT/Let				0.0
	--- Other				WT/Let				0.0
8462 29 91	--- Hydraulic				WT/Let				0.0
8462 29 99	--- Other				WT/Let				0.0
8464	Machine-tools for working stone, ceramics, concrete, asbestos-cement or like mineral materials or for cold working glass :				WT/Let				0.0
8464 10	- Sawing machines				WT/Let				0.0
8464 10 10	-- For sawing monocrystal semiconductor boules into slices, or wafers into chips	0.0	0.0	1997	WT/Let				0.0
8464 10 90	-- Other				WT/Let				0.0
8464 20	- Grinding or polishing machines				WT/Let				0.0

HS96	Description	Base rate	Bound rate	Implementation	Present concession established	Concession first incorporated in a			
						INR	GATT Schedule	Earlier INRs	ODCs
8464 20 05 --	For working semiconductor wafers	0.0	0.0	1997	WT/Let			0.0	
	-- For working glass								
8464 20 11 ---	Optical glass				WT/Let			0.0	
8464 20 19 ---	Other				WT/Let			0.0	
8464 20 80 --	Other				WT/Let			0.0	
8464 90 -	Other				WT/Let			0.0	
8464 90 10 --	For scribing or scoring semiconductor wafers	0.0	0.0	1997	WT/Let			0.0	
8464 90 90 --	Other				WT/Let			0.0	
8466	Parts and accessories suitable for use solely or principally with the machines of heading Nos 8456 to 8465, including work or tool holders, self-opening dieheads, dividing heads and other special attachments for machine-tools; tool holders for any type of tool for working in the hand :								
	- Other								
8466 91 --	For machines of heading No 8464				WT/Let			0.0	
					WT/Let			0.0	
8466 91 15 ---	For machines of subheading 8464 10 10, 8464 20 05 or 8464 90 10	1.9	0.0	2000	WT/Let			0.0	
8466 91 20 ---	Of cast iron or cast steel				WT/Let			0.0	
8466 91 95 ---	Other				WT/Let			0.0	
8466 93 --	For machines of heading Nos 8456 to 8461				WT/Let			0.0	
8466 93 15 ---	For machines and apparatus of subheading 8456 10 10, 8456 91 00, 8456 99 10 or 8456 99 30	1.9	0.0	2000	WT/Let			0.0	
8466 93 20 ---	Of cast iron or cast steel				WT/Let			0.0	
8466 93 95 ---	Other				WT/Let			0.0	
8466 94 --	For machines of heading No 8462 or 8463				WT/Let			0.0	

HS96	Description	Base rate		Bound rate	Implementation	Present concession established	INR	Concession first incorporated in a	
		1.9	0.0					GATT Schedule	Earlier INRs
8466 94 10	--- For machines of subheading 8462 21 05 or 8452 29 05	1.9	0.0	2000	2000	WT/Let			0.0
8466 94 90	--- Other					WT/Let			0.0
	- Automatic typewriters and word-processing machines					WT/Let			0.0
8469 11 00	-- Word-processing machines	3.2	0.0	2000	2000	WT/Let			0.0
8470	Calculating machines and pocket-size data recording, reproducing and displaying machines with calculating functions; accounting machines, postage-franking machines, ticket-issuing machines and similar machines, incorporating a calculating device; cash registers :					WT/Let			0.0
8470 10	- Electronic calculators capable of operation without an external source of electric power and pocket-size data recording, reproducing and displaying machines with calculating functions					WT/Let			0.0
8470 10 10	-- Electronic calculators capable of operation without an external source of electric power	8.4	0.0	2000	2000	WT/Let			0.0
8470 10 90	-- Pocket-size data recording, reproducing and displaying machines with calculating functions	5.0	0.0	2000	2000	WT/Let			0.0
	- Other electronic calculating machines					WT/Let			0.0
8470 21 00	-- Incorporating a printing device	8.4	0.0	2000	2000	WT/Let			0.0
8470 29 00	-- Other	8.4	0.0	2000	2000	WT/Let			0.0
8470 30 00	- Other calculating machines	2.8	0.0	2000	2000	WT/Let			0.0
8470 40 00	- Accounting machines	2.8	0.0	2000	2000	WT/Let			0.0
8470 50 00	- Cash registers	2.8	0.0	2000	2000	WT/Let			0.0
8470 90 00	- Other	2.8	0.0	2000	2000	WT/Let			0.0

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8471	Automatic data-processing machines and units thereof; magnetic or optical readers, machines for transcribing data onto data media in coded form and machines for processing such data, not elsewhere specified or included :				WT/Let			0.0
8471 10	- Analogue or hybrid automatic data-processing machines				WT/Let			0.0
8471 10 10	-- For use in civil aircraft	0.0	0.0	1997	WT/Let			0.0
8471 10 90	-- Other	3.5	0.0	2000	WT/Let			0.0
8471 30 00	- Portable digital automatic data-processing machines, weighing not more than 10 kg, consisting of at least a central processing unit, a keyboard and a display	3.5	0.0	2000	WT/Let			0.0
8471 41	- Other digital automatic data-processing machines				WT/Let			0.0
8471 41 10	-- Comprising in the same housing at least a central processing unit and an input and output unit, whether or not combined				WT/Let			0.0
8471 41 10 ---	For use in civil aircraft	0.0	0.0	1997	WT/Let			0.0
8471 41 90	--- Other	3.5	0.0	2000	WT/Let			0.0
8471 49	-- Other, presented in the form of systems				WT/Let			0.0
8471 49 10	--- For use in civil aircraft	0.0	0.0	1997	WT/Let			0.0
8471 49 90	--- Other	3.5	0.0	2000	WT/Let			0.0
8471 50	- Digital processing units other than those of subheadings No 8471 41 and 8471 49, whether or not containing in the same housing one or two of the following types of unit: storage units, input units, output units				WT/Let			0.0
8471 50 10	-- For use in civil aircraft	0.0	0.0	1997	WT/Let			0.0
8471 50 90	-- Other	3.5	0.0	2000	WT/Let			0.0

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation</u>	<u>Present concession established</u>	<u>INR</u>	<u>Concession first incorporated in a GATT Schedule</u>	<u>Earlier INRs</u>	<u>ODCs</u>
8471 60	- Input or output units, whether or not containing storage units in the same housing				WT/Let				0.0
8471 60 10	-- For use in civil aircraft	0.0	0.0	1997	WT/Let				0.0
	-- Other				WT/Let				0.0
8471 60 40	--- Printers	2	0.0	1999	WT/Let				0.0
8471 60 50	--- Keyboards	2	0.0	1999	WT/Let				0.0
8471 60 90	--- Other	2	0.0	1999	WT/Let				0.0
8471 70	- Storage units				WT/Let				0.0
8471 70 10	-- For use in civil aircraft	0.0	0.0	1997	WT/Let				0.0
	-- Other				WT/Let				0.0
8471 70 40	--- Central storage units	2	0.0	1999	WT/Let				0.0
	--- Other				WT/Let				0.0
	--- Disk storage units				WT/Let				0.0
8471 70 51	----- Optical, including magneto-optical	2	0.0	1999	WT/Let				0.0
	----- Other				WT/Let				0.0
8471 70 53	----- Hard disk drives	1.6	0.0	1999	WT/Let				0.0
8471 70 59	----- Other	2	0.0	1999	WT/Let				0.0
8471 70 60	--- Magnetic tape storage units	2	0.0	1999	WT/Let				0.0
8471 70 90	--- Other	2	0.0	1999	WT/Let				0.0
8471 80	- Other units of automatic data-processing machines				WT/Let				0.0
8471 80 10	-- Peripheral units	2	0.0	1999	WT/Let				0.0
8471 80 90	-- Other	2	0.0	1999	WT/Let				0.0
8471 90 00	- Other	2	0.0	1999	WT/Let				0.0
8472	Other office machines (for example, hectograph or stencil duplicating machines, addressing machines, automatic banknote dispensers, coin-sorting machines, coin-counting or wrapping machines, pencil-sharpening machines, perforating or stapling machines) :				WT/Let				0.0
8472 90	- Other				WT/Let				0.0

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation</u>	<u>Present concession established</u>	<u>INR</u>	<u>GATT Schedule</u>	<u>Concession first incorporated in a</u>	<u>Earlier INRs</u>	<u>ODCs</u>
8472 90 10 --	Coin-sorting, coin-counting or coin-wrapping machines				WT/Let					0.0
8472 90 30 --	Automatic teller machines	3.1	0.0	2000	WT/Let					0.0
8472 90 80 --	Other				WT/Let					0.0
8473	Parts and accessories (other than covers, carrying cases and the like) suitable for use solely or principally with machines of heading Nos 8469 to 8472 :				WT/Let					0.0
8473 10 -	Parts and accessories of the machines of heading No 8469				WT/Let					0.0
8473 10 11 --	Printed circuit assemblies for products of subheading No 8469 11	3.4	0.0	2000	WT/Let					0.0
8473 10 19 --	Other				WT/Let					0.0
8473 21 --	Of the electronic calculating machines of subheading 8470 10, 8470 21 or 8470 29				WT/Let					0.0
8473 21 10 ---	Electronic assemblies	4.3	0.0	2000	WT/Let					0.0
8473 21 90 ---	Other	2.5	0.0	1999	WT/Let					0.0
8473 29 --	Other				WT/Let					0.0
8473 29 10 ---	Electronic assemblies	3.4	0.0	2000	WT/Let					0.0
8473 29 90 ---	Other	1.6	0.0	1999	WT/Let					0.0
8473 30 -	Parts and accessories of the machines of heading No 8471				WT/Let					0.0
8473 30 10 --	Electronic assemblies	3.3	0.0	2000	WT/Let					0.0
8473 30 90 --	Other	1.6	0.0	1999	WT/Let					0.0
8473 40 -	Parts and accessories of the machines of heading No 8472				WT/Let					0.0
8473 40 11 --	Printed circuit assemblies for products of subheading 8472 90 30	3.4	0.0	2000	WT/Let					0.0
8473 40 19 --	Other				WT/Let					0.0
8473 50 -	Parts and accessories equally suitable for use with machines of two or more of the headings Nos 8469 to 8472				WT/Let					0.0
8473 50 10 --	Electronic assemblies	3.4	0.0	2000	WT/Let					0.0
8473 50 90 --	Other	1.6	0.0	1999	WT/Let					0.0